Operational Amplifier Series

# Automotive Low Noise Operational Amplifiers

## BA4558Yxxx-M

### ●General Description

BA4558Yxxx-M integrates two independent Op-Amps on a single chip. This Op-Amp has some features of low noise and low distortion characteristics and can operate from ±4.0V to ±15V(split supply).
BA4558Yxxx-M is manufactured for automotive requirements of car navigation system, car audio, etc.

### ●Features

- AEC-Q100 Qualified
- High voltage gain
- low noise
- low distortion
- Wide operating supply voltage
- Internal ESD protection circuit
- Wide operating temperature Range

### ●Application

- Car Navigation System
- Car Audio

### ●Key Specifications

- Wide operating supply voltage (split supply):±4.0V to ±15V
- Wide Temperature Range: -40°C to +105°C
- High Slew Rate: 1V/µs(Typ.)
- Total Harmonic Distortion : 0.005%(Typ.)
- Input Referred Noise Voltage : 12 nV/√Hz (Typ.)

### ●Packages

| | W(Typ.) x D(Typ.) x (Max.) |
|---|---|
| SOP8 | 5.00mm x 6.20mm x 1.71mm |
| SSOP-B8 | 3.00mm x 6.40mm x 1.35mm |
| MSOP8 | 2.90mm x 4.00mm x 0.90mm |

### ●Simplified schematic

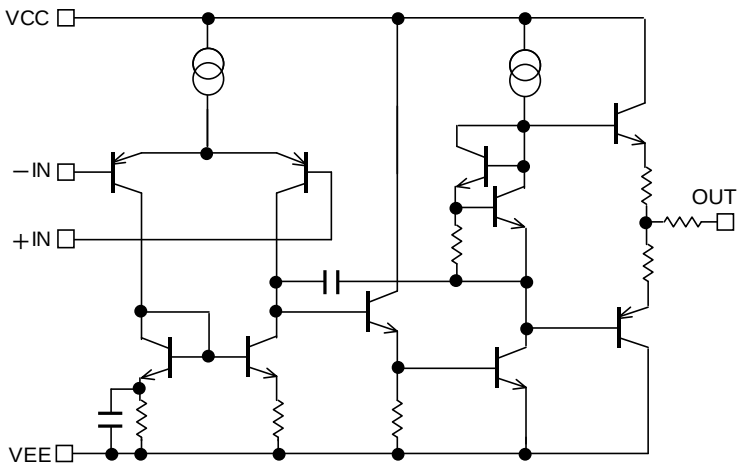


Figure 1. Simplified schematic (one channel only)

○Product structure : Silicon monolithic integrated circuit ○This product is not designed protection against radioactive rays.

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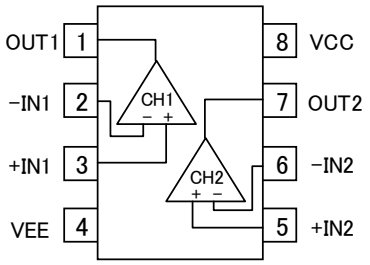
## ●Pin Configuration

BA4558YF-M : SOP8
BA4558YFV-M : SSOP-B8
BA4558YFVM-M : MSOP8




| Pin No. | Symbol |
|---|---|
| 1 | OUT1 |
| 2 | -IN1 |
| 3 | +IN1 |
| 4 | VEE |
| 5 | +IN2 |
| 6 | -IN2 |
| 7 | OUT2 |
| 8 | VCC |

| Package | | |
|---|---|---|
| SOP8 | SSOP-B8 | MSOP8 |
| BA4558YF-M | BA4558YFV-M | BA4558YFVM-M |

## ●Ordering Information

B A 4 5 5 8 Y x x x - M x x

Parts Number.
BA4558Yxxx

Package
F : SOP8
FV : SSOP-B8
FVM : MSOP8

Packaging and forming specification
M : Automotive（car navigation system, car audio, etc.）
E2: Embossed tape and reel
(SOP8/SSOP-B8)
TR: Embossed tape and reel
(MSOP8)

## ●Line-up

| Topr | Supply voltage | Number of channels | Package | | Orderable Parts Number |
|---|---|---|---|---|---|
| -40°C to +105°C | ±4.0V to ±15V | Dual | SOP8 | Reel of 2500 | BA4558YF-ME2 |
| | | | SSOP-B8 | Reel of 2500 | BA4558YFV-ME2 |
| | | | MSOP8 | Reel of 3000 | BA4558YFVM-MTR |

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●**Absolute Maximum Ratings**(Ta=25℃)

| Parameter | Symbol | | Ratings | Unit |
|---|---|---|---|---|
| Supply Voltage | VCC-VEE | | +36 | V |
| Power Dissipation | Pd | SOP8 | 775[*1*4] | mW |
| | | SSOP-B8 | 625[*2*4] | |
| | | MSOP8 | 600[*3*4] | |
| Differential Input Voltage [*5] | Vid | | +36 | V |
| Input Common-mode Voltage Range | Vicm | | (VEE-0.3) to (VEE+36) | V |
| Operating Supply Voltage | Vopr | | +8.0 to +30<br>(±4.0 to ±15) | V |
| Operating Temperature Range | Topr | | -40 to +105 | ℃ |
| Storage Temperature Range | Tstg | | -55 to +150 | ℃ |
| Maximum Junction Temperature | Tjmax | | +150 | ℃ |

Note: Absolute maximum rating item indicates the condition which must not be exceeded.
Application if voltage in excess of absolute maximum rating or use out of absolute maximum rated temperature environment may cause deterioration of characteristics.

*1 To use at temperature above Ta＝25℃ reduce 6.2mW/℃.
*2 To use at temperature above Ta＝25℃ reduce 5.0mW/℃.
*3 To use at temperature above Ta＝25℃ reduce 4.8mW/℃.
*4 Mounted on a FR4 glass epoxy PCB(70mm×70mm×1.6mm).
*5 The voltage difference between inverting input and non-inverting input is the differential input voltage.
Then input terminal voltage is set to more than VEE.

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## ●Electrical Characteristics

○BA4558Yxxx-M (Unless otherwise specified VCC=+15V, VEE=-15V, Full range -40℃ to +105℃)

| Parameter | Symbol | Temperature Range | Limits | | | Unit | Condition |
|---|---|---|---|---|---|---|---|
| | | | Min. | Typ. | Max. | | |
| Input Offset Voltage *6 | Vio | 25℃ | - | 0.5 | 6 | mV | OUT=0V |
| | | Full range | - | - | 7 | | |
| Input Offset Current *6 | Iio | 25℃ | - | 5 | 200 | nA | OUT=0V |
| | | Full range | - | - | 200 | | |
| Input Bias Current *7 | Ib | 25℃ | - | 60 | 500 | nA | OUT=0V |
| | | Full range | - | - | 800 | | |
| Supply Current | ICC | 25℃ | - | 3 | 6 | mA | RL=∞, All Op-Amps VIN+=0V |
| | | Full range | - | - | 6.5 | | |
| Maximum Output Voltage | VOM | 25℃ | ±10 | ±13 | - | V | RL≧2kΩ |
| | | Full range | ±10 | - | - | | |
| | | 25℃ | ±12 | ±14 | - | | RL≧10kΩ |
| Large Signal Voltage Gain | Av | 25℃ | 86 | 100 | - | dB | RL≧2kΩ, OUT=±10V Vicm=0V |
| | | Full range | 83 | - | - | | |
| Input Common-mode Voltage Range | Vicm | 25℃ | ±12 | ±14 | - | V | - |
| | | Full range | ±12 | - | - | | |
| Common-mode Rejection Ratio | CMRR | 25℃ | 70 | 90 | - | dB | Ri≦10kΩ |
| Power Supply Rejection Ratio | PSRR | 25℃ | 76.5 | 90 | - | dB | Ri≦10kΩ |
| Slew Rate | SR | 25℃ | - | 1 | - | V/μs | Av=0dB, RL=2kΩ CL=100pF |
| Unity Gain Frequency | $f_T$ | 25℃ | - | 2 | - | MHz | RL=2kΩ |
| Total Harmonic Distortion +Noise | THD+N | 25℃ | - | 0.005 | - | % | Av=20dB, RL=10kΩ VIN=0.05Vrms, f=1kHz |
| Input Referred Noise Voltage | Vn | 25℃ | - | 12 | - | $nV/\sqrt{Hz}$ | RS=100Ω, Vi=0V, f=1kHz |
| | | | - | 1.8 | - | μVrms | RS=100Ω Vi=0V, DIN-AUDIO |
| Channel Separation | CS | 25℃ | - | 105 | - | dB | R1=100Ω, f=1kHz |

*6 Absolute value
*7 Current direction: Since first input stage is composed with PNP transistor, input bias current flows out of IC.

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**Description of electrical characteristics**

Described here are the terms of electric characteristics used in this datasheet. Items and symbols used are also shown.
Note that item name and symbol and their meaning may differ from those on another manufacture's document or general document.

**1. Absolute maximum ratings**

Absolute maximum rating item indicates the condition which must not be exceeded. Application of voltage in excess of absolute maximum rating or use out of absolute maximum rated temperature environment may cause deterioration of characteristics.

1.1 Power supply voltage (VCC-VEE)
Indicates the maximum voltage that can be applied between the positive power supply terminal and negative power supply terminal without deterioration or destruction of characteristics of internal circuit.

1.2 Differential input voltage (Vid)
Indicates the maximum voltage that can be applied between non-inverting terminal and inverting terminal without deterioration and destruction of characteristics of IC.

1.3 Input common-mode voltage range (Vicm)
Indicates the maximum voltage that can be applied to non-inverting terminal and inverting terminal without deterioration or destruction of characteristics. Input common-mode voltage range of the maximum ratings not assure normal operation of IC. When normal operation of IC is desired, the input common-mode voltage of characteristics item must be followed.

1.4 Power dissipation (Pd)
Indicates the power that can be consumed by specified mounted board at the ambient temperature 25℃(normal temperature).
As for package product, Pd is determined by the temperature that can be permitted by IC chip in the package (maximum junction temperature)and thermal resistance of the package.

**2. Electrical characteristics item**

2.1 Input offset voltage (Vio)
Indicates the voltage difference between non-inverting terminal and inverting terminal. It can be translated into the input voltage difference required for setting the output voltage at 0V.

2.2 Input offset current (Iio)
Indicates the difference of input bias current between non-inverting terminal and inverting terminal.

2.3 Input bias current (Ib)
Indicates the current that flows into or out of the input terminal. It is defined by the average of input bias current at non-inverting terminal and input bias current at inverting terminal.

2.4 Circuit current (ICC)
Indicates the IC current that flows under specified conditions and no-load steady status.

2.5 Output saturation voltage (VOM)
Signifies the voltage range that can be output under specific output conditions.

2.6 Large signal voltage gain (Av)
Indicates the amplifying rate (gain) of output voltage against the voltage difference between non-inverting terminal and Inverting terminal. It is normally the amplifying rate (gain) with reference to DC voltage.
Av = (Output voltage) / (Differential Input voltage)

2.7 Input common-mode voltage range (Vicm)
Indicates the input voltage range where IC operates normally.

2.8 Common-mode rejection ratio (CMRR)
Indicates the ratio of fluctuation of input offset voltage when in-phase input voltage is changed. It is normally the fluctuation of DC.
CMRR = (Change of Input common-mode voltage)/(Input offset fluctuation)

2.9 Power supply rejection ratio (PSRR)
Indicates the ratio of fluctuation of input offset voltage when supply voltage is changed. It is normally the fluctuation of DC.
PSRR = (Change of power supply voltage) / (Input offset fluctuation)

2.10 Slew Rate (SR)
SR is a parameter that shows movement speed of operational amplifier. It indicates rate of variable output voltage as unit time.

2.11 Unity gain frequency ($f_T$)
Indicates a frequency where the voltage gain of operational amplifier is 1.

2.12 Total harmonic distortion + Noise (THD+N)
Indicates the fluctuation of input offset voltage or that of output voltage with reference to the change of output voltage of driven channel.

2.13 Input referred noise voltage (Vn)
Indicates a noise voltage generated inside the operational amplifier equivalent by ideal voltage source connected in series with input terminal.

2.14 Channel separation (CS)
Indicates the fluctuation of input offset voltage or that of output voltage with reference to the change of output voltage of driven channel.

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●**Typical Performance Curves**

○BA4558Yxxx-M

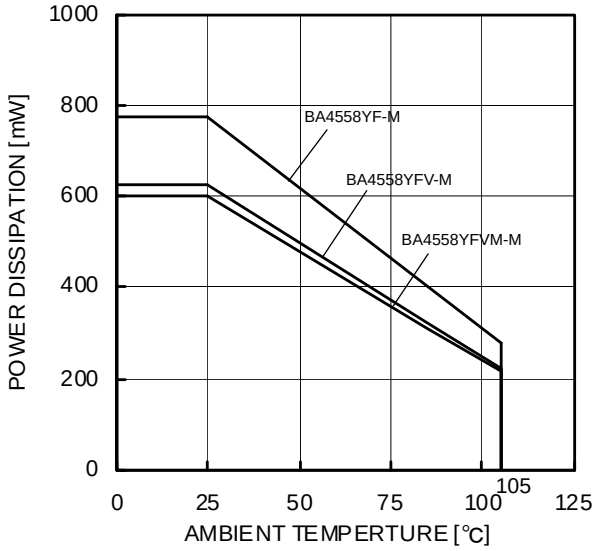


Figure 2.
Derating Curve

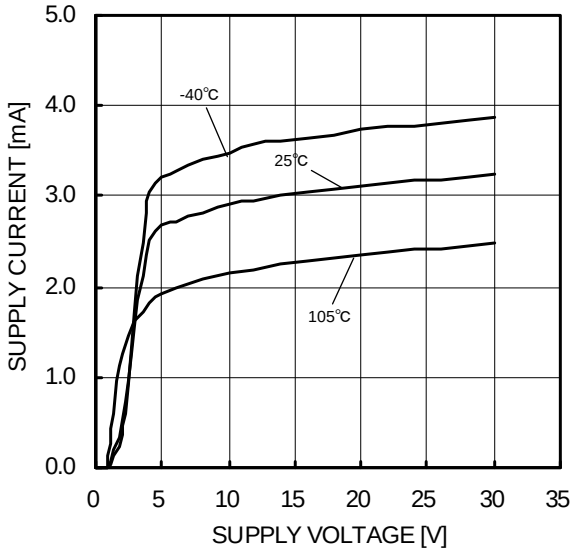


Figure 3.
Supply Current - Supply Voltage

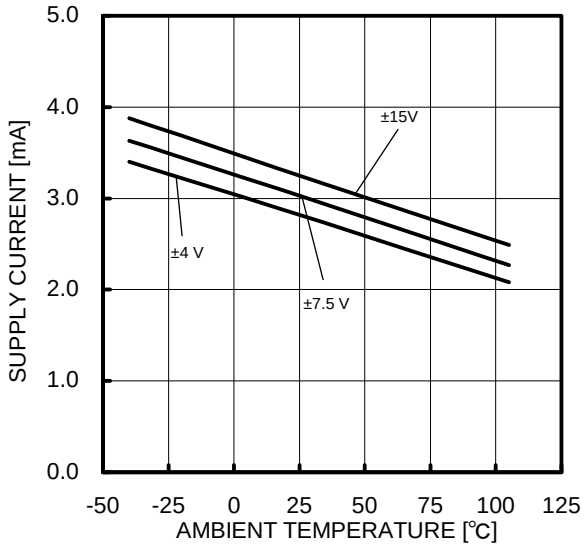


Figure 4.
Supply Current - Ambient Temperature

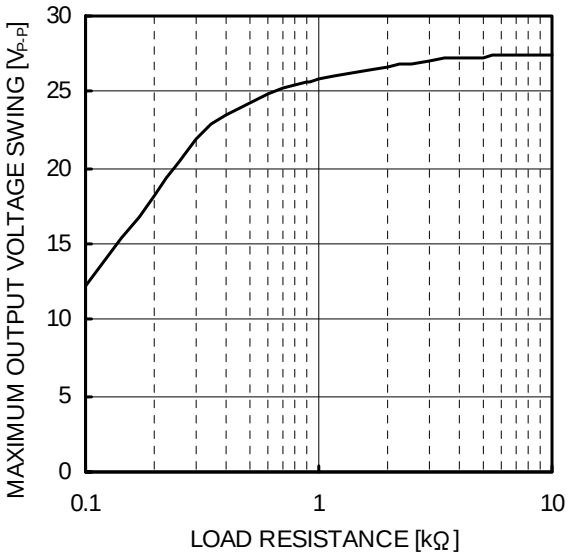


Figure 5.
Maximum Output Voltage Swing
- Load Resistance
(VCC/VEE=+15V/-15V, Ta=25℃)

(*) The above data is measurement value of typical sample, it is not guaranteed.

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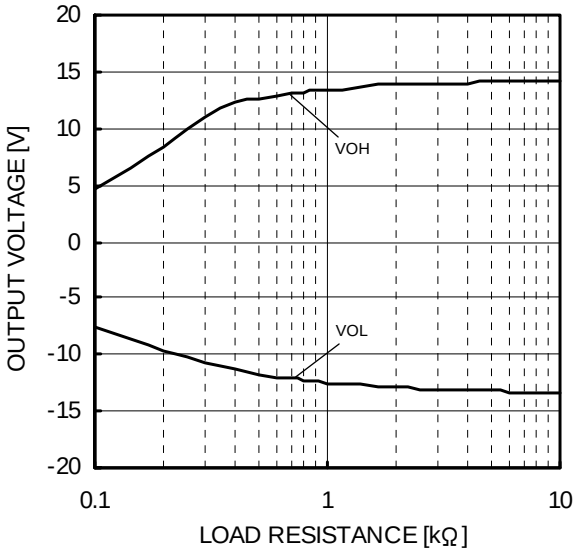


Figure 6.
Maximum Output Voltage
- Load Resistance
(VCC/VEE=+15V/-15V, Ta=25℃)

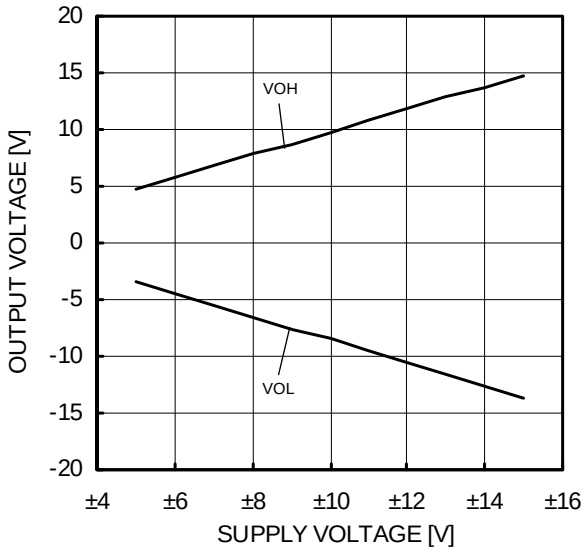


Figure 7.
Maximum Output Voltage
- Supply Voltage
(RL=2kΩ, Ta=25℃)

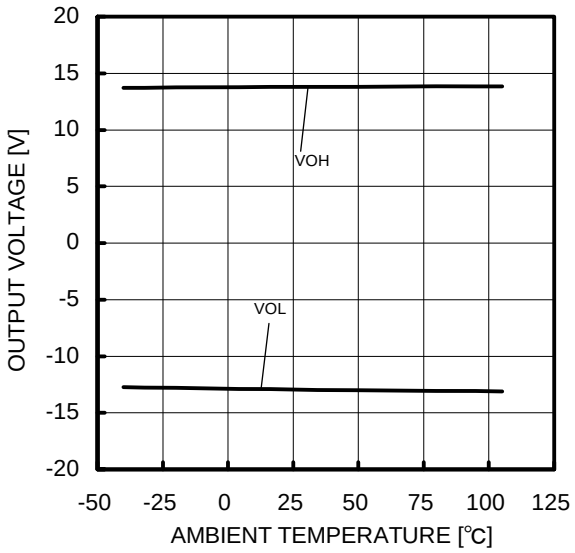


Figure 8.
Maximum Output Voltage
- Ambient Temperature
(VCC/VEE=+15V/-15V, RL=2kΩ)

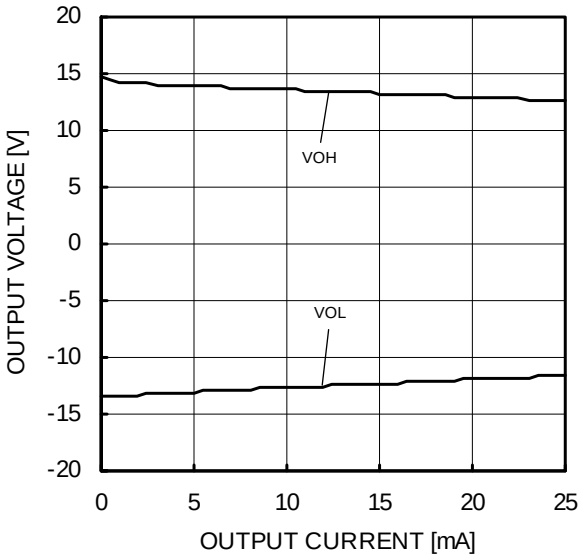


Figure 9.
Maximum Output Voltage
- Output Current
(VCC/VEE=+15V/-15V, Ta=25℃)

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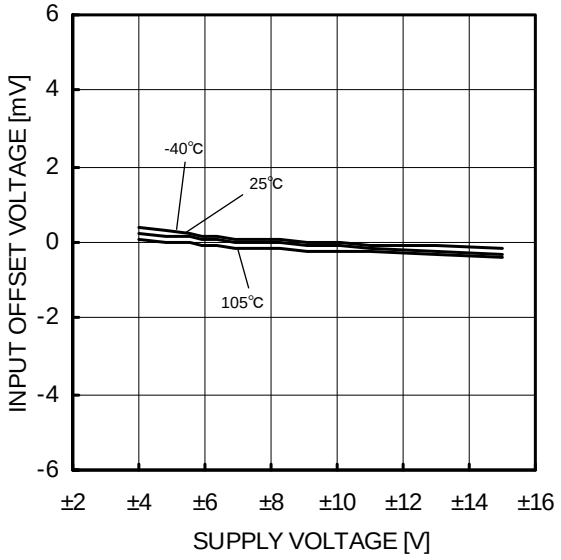


Figure 10.
Input Offset Voltage - Supply Voltage
(Vicm=0V, OUT=0V)

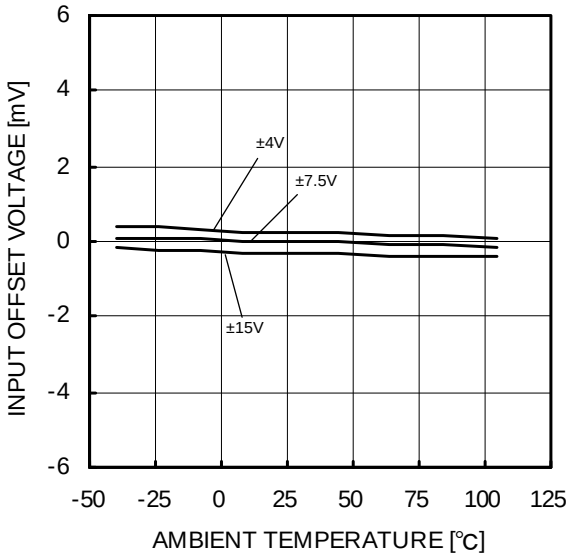


Figure 11.
Input Offset Voltage - Ambient Temperature
(Vicm=0V, OUT=0V)

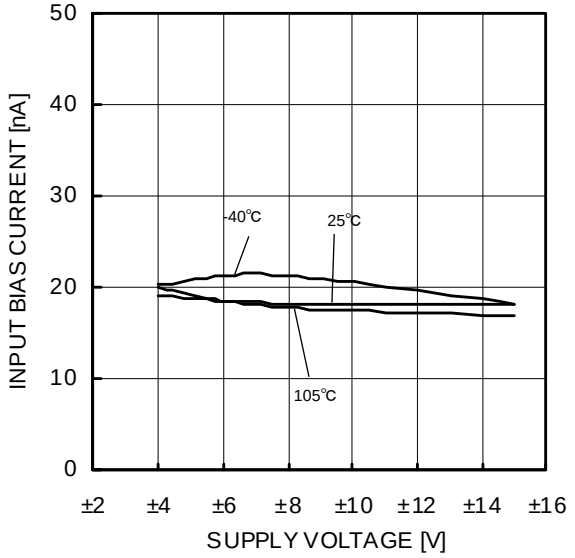


Figure 12.
Input Bias Current - Supply Voltage
(Vicm=0V, OUT=0V)

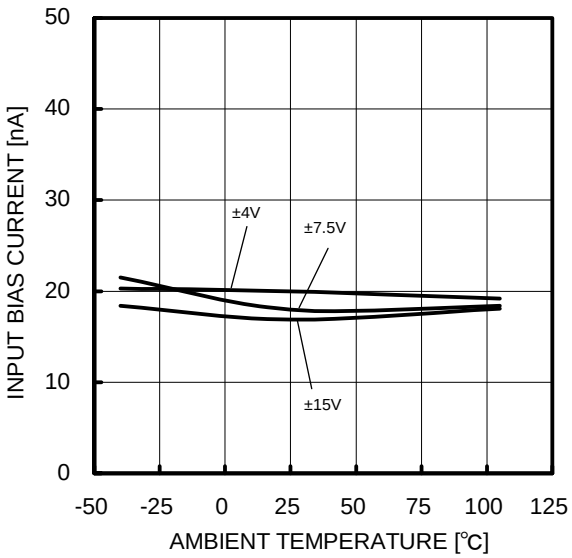


Figure 13.
Input Bias Current - Ambient Temperature
(Vicm=0V, OUT=0V)

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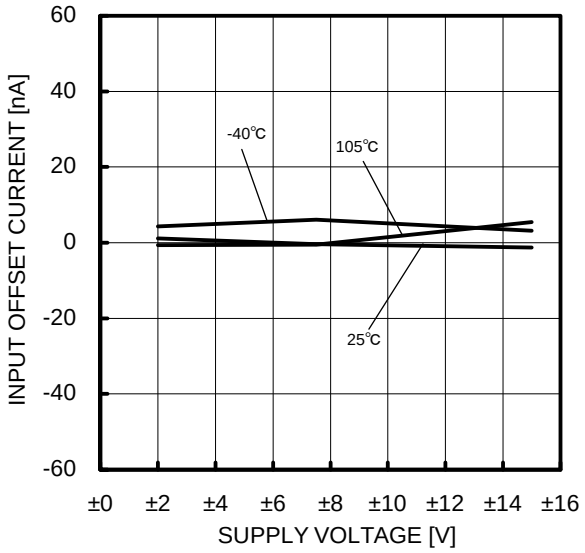


Figure 14.
Input Offset Current - Supply Voltage
(Vicm=0V, OUT=0V)

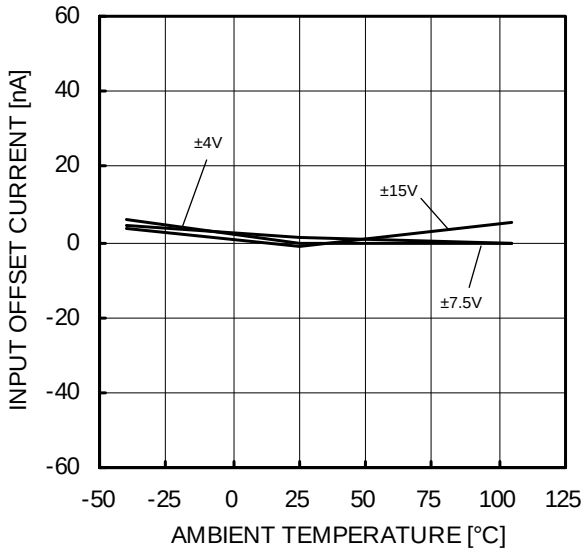


Figure 15.
Input Offset Current - Ambient Temperature
(Vicm=0V, OUT=0V)

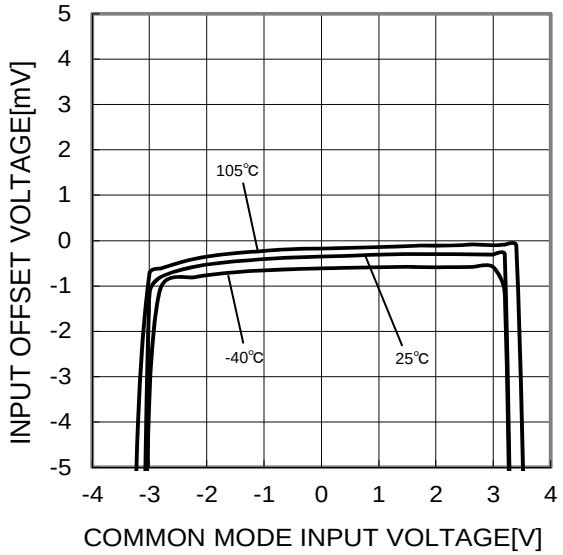


Figure 16.
Input Offset Voltage
- Common Mode Input Voltage
(VCC=4V, VEE=-4V, OUT=0V)

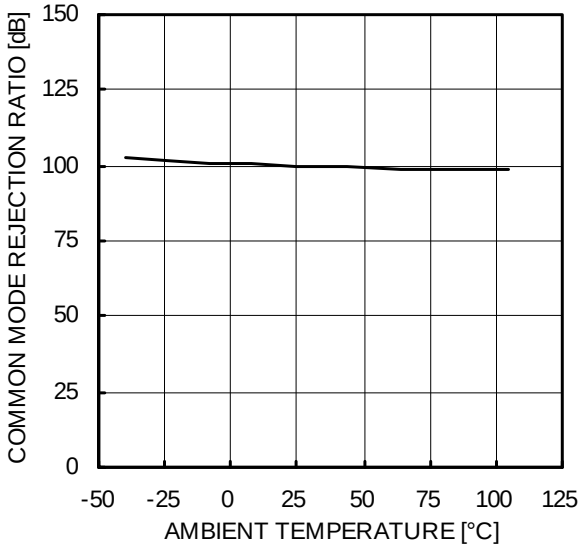


Figure 17.
Common Mode Rejection Ratio
- Ambient Temperature
(VCC/VEE=+15V/-15V, Vicm=-12V to +12V)

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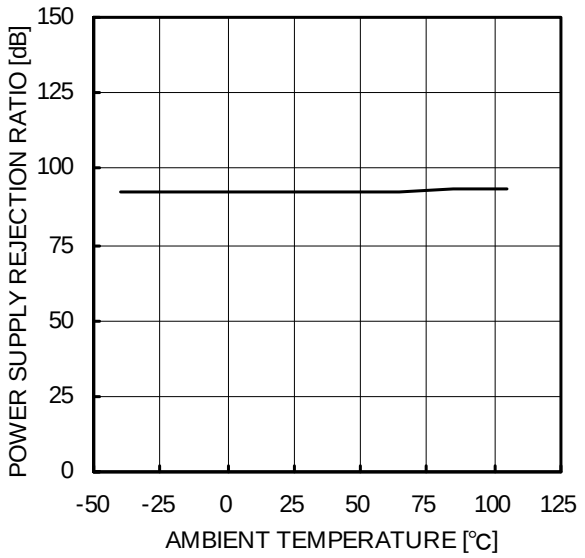


Figure 18.
Power Supply Rejection Ratio
- Ambient Temperature
(VCC/VEE=+4V/-4V to +15V/-15V)

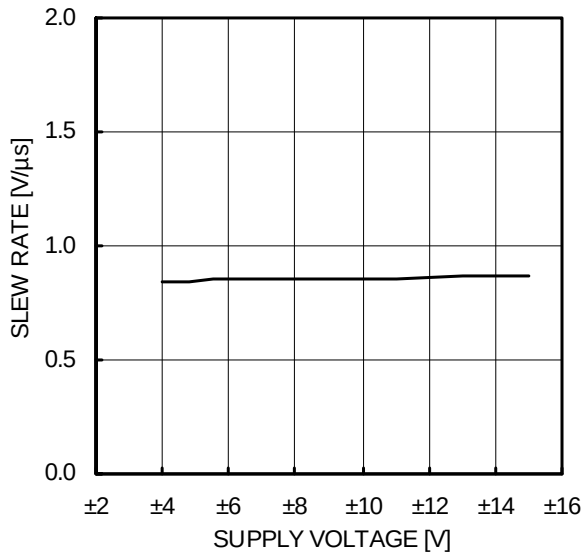


Figure 19.
Slew Rate - Supply Voltage
(CL=100pF, RL=2kΩ, Ta=25℃)

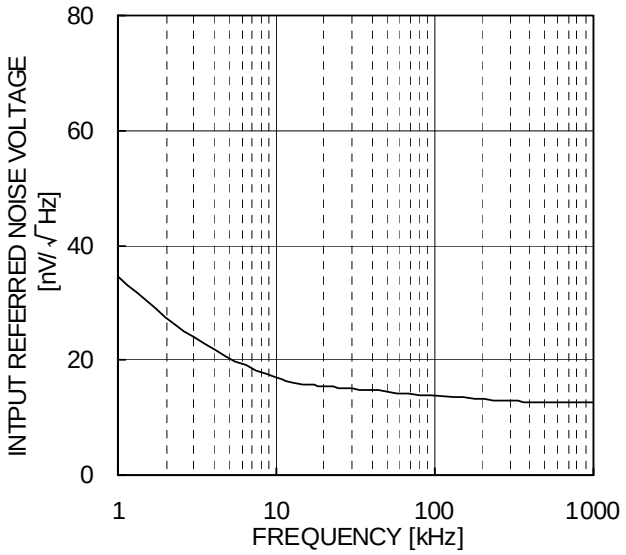


Figure 20.
Equivalent Input Noise Voltage - Frequency
VCC/VEE=+15V/-15V, RS=100Ω, Ta=25℃)

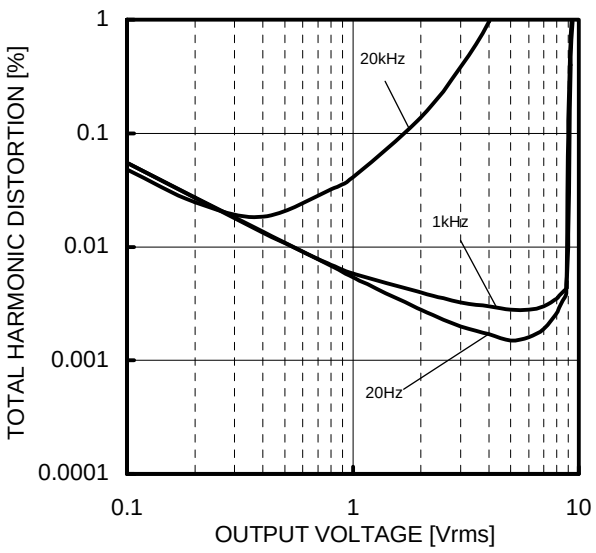


Figure 21.
Total Harmonic Distortion - Output Voltage
(VCC/VEE=+15V/-15V,Av=20dB,
RL=2kΩ, 80kHz-LPF, Ta=25℃)

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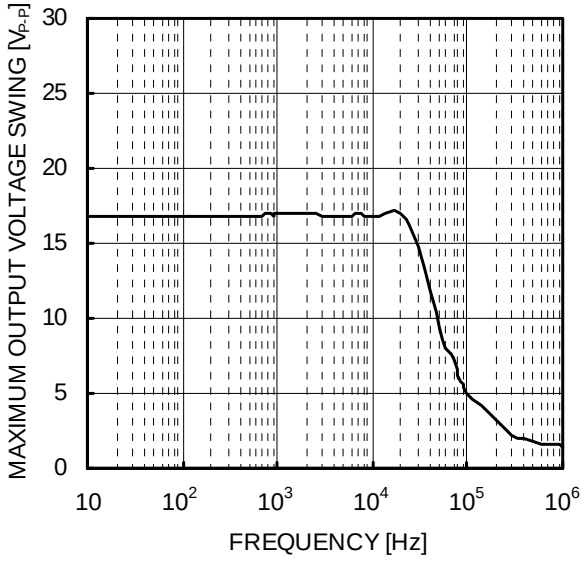


Figure 22.
Maximum Output Voltage Swing – Frequency
(VCC/VEE=+15V/-15V, RL=2kΩ, Ta=25℃)

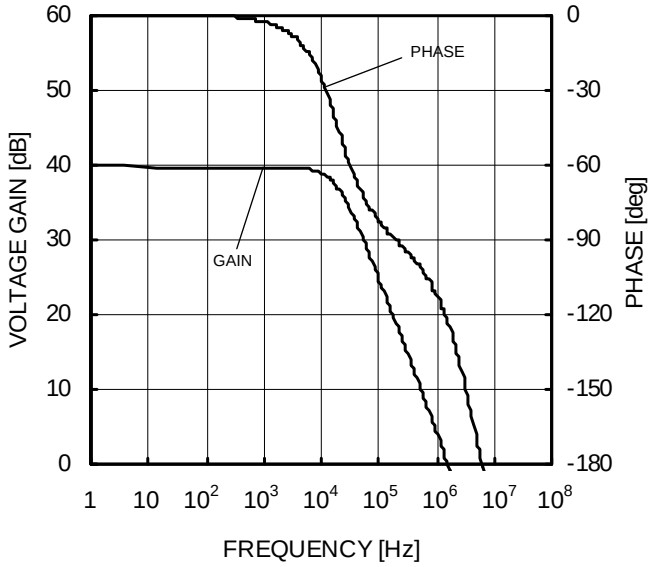


Figure 23.
Voltage Gain, Phase - Frequency
(VCC/VEE=+15V/-15V, Av=40dB, RL=2kΩ, Ta=25℃)

(*) The above data is measurement value of typical sample, it is not guaranteed.

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## ●Power Dissipation

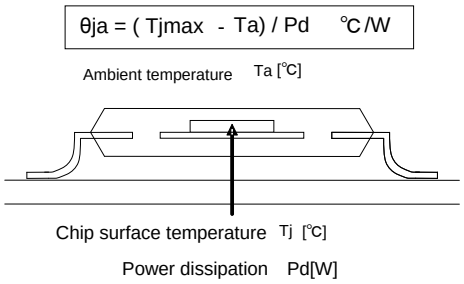
Power dissipation (total loss) indicates the power that the IC can consume at Ta=25°C (normal temperature). As the IC consumes power, it heats up, causing its temperature to be higher than the ambient temperature. The allowable temperature that the IC can accept is limited. This depends on the circuit configuration, manufacturing process, and consumable power.

Power dissipation is determined by the allowable temperature within the IC (maximum junction temperature) and the thermal resistance of the package used (heat dissipation capability). Maximum junction temperature is typically equal to the maximum storage temperature. The heat generated through the consumption of power by the IC radiates from the mold resin or lead frame of the package. Thermal resistance, represented by the symbol θja°C/W, indicates this heat dissipation capability. Similarly, the temperature of an IC inside its package can be estimated by thermal resistance.

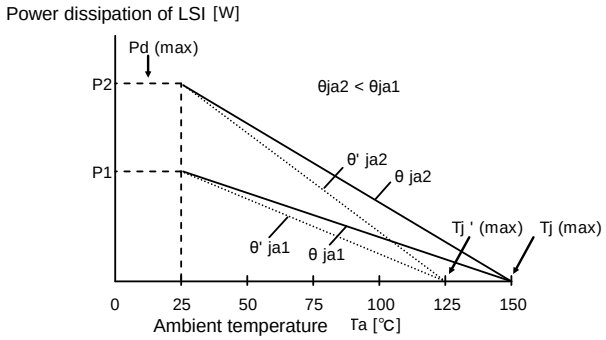
Figure 24. (a) shows the model of the thermal resistance of the package. The equation below shows how to compute for the Thermal resistance (θja), given the ambient temperature (Ta), maximum junction temperature (Tjmax), and power dissipation (Pd).

$$\theta ja = (Tjmax - Ta) / Pd \quad ℃/W \qquad \cdots\cdots \quad (\mathrm{I})$$

The Derating curve in Figure 24. (b) indicates the power that the IC can consume with reference to ambient temperature. Power consumption of the IC begins to attenuate at certain temperatures. This gradient is determined by Thermal resistance (θja), which depends on the chip size, power consumption, package, ambient temperature, package condition, wind velocity, etc. This may also vary even when the same of package is used. Thermal reduction curve indicates a reference value measured at a specified condition. Figure 25. (c) shows an example of the derating curve for BA4558Yxxx-M.

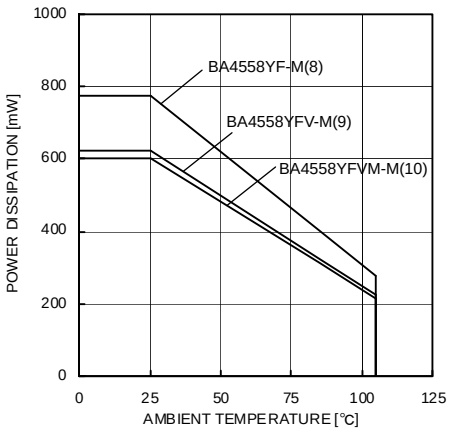



(a) Thermal resistance




(b) Derating curve

Figure 24. Thermal resistance and derating




(c) BA4558Yxxx-M

| ( 8 ) | ( 9 ) | (10) | Unit |
|---|---|---|---|
| 6.2 | 5.0 | 4.8 | mW/℃ |

When using the unit above Ta=25℃, subtract the value above per Celsius degree .
Mounted on a FR4 glass epoxy board 70mm×70mm×1.6mm(cooper foil area below 3%)

Figure 25. Derating curve

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## ●Application Information

**NULL method condition for Test circuit1**

VCC, VEE, EK, Vicm Unit: V

| Parameter | VF | S1 | S2 | S3 | VCC | VEE | EK | Vicm | calculation |
|---|---|---|---|---|---|---|---|---|---|
| Input Offset Voltage | VF1 | ON | ON | OFF | 15 | -15 | 0 | 0 | 1 |
| Input Offset Current | VF2 | OFF | OFF | OFF | 15 | -15 | 0 | 0 | 2 |
| Input Bias Current | VF3 | OFF | ON | OFF | 15 | -15 | 0 | 0 | 3 |
| | VF4 | ON | OFF | | | | | | |
| Large Signal Voltage Gain | VF5 | ON | ON | ON | 15 | -15 | 0 | 0 | 4 |
| | VF6 | | | | 15 | -15 | 0 | 0 | |
| Common-mode Rejection Ratio (Input common-mode Voltage Range) | VF7 | ON | ON | OFF | 3 | -27 | 0 | 0 | 5 |
| | VF8 | | | | 27 | -3 | 0 | 0 | |
| Power Supply Rejection Ratio | VF9 | ON | ON | OFF | 4 | -4 | 0 | 0 | 6 |
| | VF10 | | | | 15 | -15 | 0 | 0 | |

- Calculation -

1. Input Offset Voltage (Vio)

$$Vio = \frac{|VF1|}{1 + RF/RS} \quad [V]$$

2. Input Offset Current (Iio)

$$Iio = \frac{|VF2 - VF1|}{Ri \times (1 + RF/RS)} \quad [A]$$

3. Input Bias Current (Ib)

$$Ib = \frac{|VF4 - VF3|}{2 \times Ri \times (1 + RF/RS)} \quad [A]$$

4. Large Signal Voltage Gain (Av)

$$Av = 20 \times Log \frac{\Delta EK \times (1 + RF/RS)}{|VF5 - VF6|} \quad [dB]$$

5. Common-mode Rejection Ration (CMRR)

$$CMRR = 20 \times Log \frac{\Delta Vicm \times (1 + RF/RS)}{|VF8 - VF7|} \quad [dB]$$

6. Power supply rejection ratio (PSRR)

$$PSRR = 20 \times Log \frac{\Delta Vcc \times (1 + RF/RS)}{|VF10 - VF9|} \quad [dB]$$

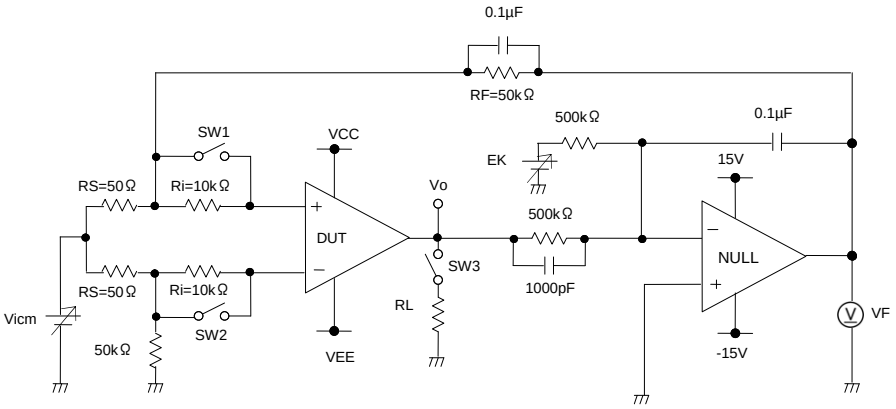



Figure 26. Test circuit1 (one channel only)

**Switch Condition for Test Circuit 2**

| SW No. | SW 1 | SW 2 | SW 3 | SW 4 | SW 5 | SW 6 | SW 7 | SW 8 | SW 9 | SW 10 | SW 11 | SW 12 | SW 13 | SW 14 |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| Supply Current | OFF | OFF | OFF | ON | OFF | ON | OFF | OFF | OFF | OFF | OFF | OFF | OFF | OFF |
| Maximum Output Voltage (high) | OFF | OFF | ON | OFF | OFF | ON | OFF | OFF | ON | OFF | OFF | OFF | ON | OFF |
| Maximum Output Voltage (Low) | OFF | OFF | ON | OFF | OFF | ON | OFF | OFF | ON | OFF | OFF | OFF | ON | OFF |
| Output Source Current | OFF | OFF | ON | OFF | OFF | ON | OFF | OFF | OFF | OFF | OFF | OFF | OFF | ON |
| Output Sink Current | OFF | OFF | ON | OFF | OFF | ON | OFF | OFF | OFF | OFF | OFF | OFF | OFF | ON |
| Slew Rate | OFF | OFF | OFF | ON | OFF | OFF | OFF | ON | ON | ON | ON | OFF | OFF | OFF |
| Gain Bandwidth Product | OFF | ON | OFF | OFF | ON | ON | OFF | OFF | ON | ON | ON | OFF | OFF | OFF |
| Equivalent Input Noise Voltage | ON | OFF | OFF | OFF | ON | ON | OFF | OFF | OFF | OFF | ON | OFF | OFF | OFF |

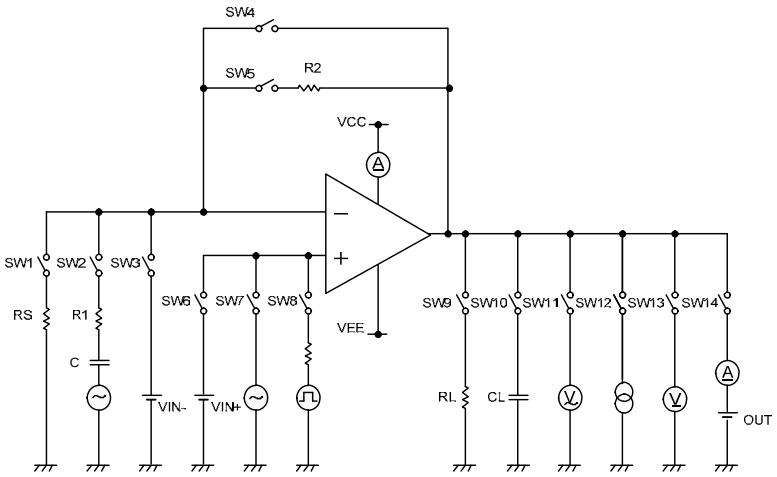



Figure 27. Test Circuit 2 (each Op-Amp)

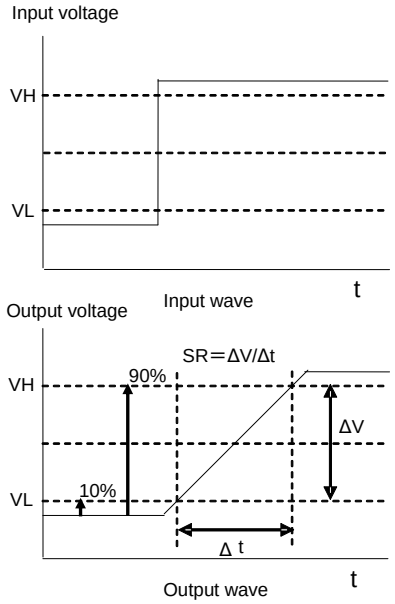
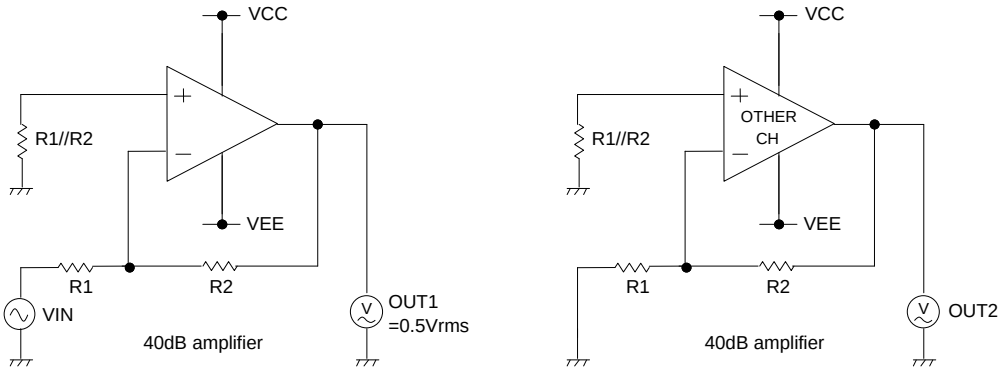



Figure 28. Slew Rate Input Waveform




$$CS = 20 \times \log \frac{100 \times OUT1}{OUT2}$$

(R1=1kΩ, R2=100kΩ)

Figure 29. Test Circuit 3(Channel Separation)

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## ●Operational Notes

1) Processing of unused circuit
It is recommended to apply connection (see the Figure 30.) and set the non inverting input terminal at the potential within input common-mode voltage range (Vicm), for any unused circuit.

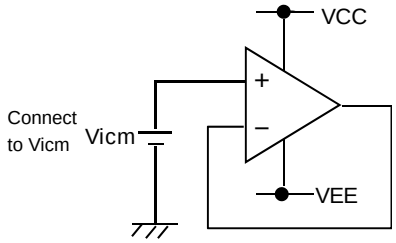


Figure 30. The example of application circuit for unused op-amp

2) Input voltage
Applying (VEE - 0.3) to (VEE + 36)V
(BA4558R) to the input terminal is possible without causing deterioration of the electrical characteristics or destruction, irrespective of the supply voltage. However, this does not ensure normal circuit operation. Please note that the circuit operates normally only when the input voltage is within the common mode input voltage range of the electric characteristics.

3) Maximum output voltage
Because the output voltage range becomes narrow as the output current Increases, design the application with margin by considering changes in electrical characteristics and temperature characteristics.

4) Short-circuit of output terminal
When output terminal and VCC or VEE terminal are shorted, excessive Output current may flow under some conditions, and heating may destroy IC. It is necessary to connect a resistor as shown in Figure 31., thereby protecting against load shorting.

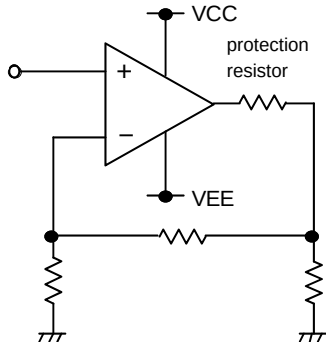


Figure 31. The example of output short protection

5) Power supply (split supply / single supply) in used
Op-amp operates when specified voltage is applied between VCC and VEE. Therefore, the single supply Op-Amp can be used for double supply Op-Amp as well.

6) Power dissipation (Pd)
Use a thermal design that allows for a sufficient margin in light of the power dissipation (Pd) in actual operating conditions.

7) Short-circuit between pins and wrong mounting
Pay attention to the assembly direction of the ICs. Wrong mounting direction or shorts between terminals, GND, or other components on the circuits, can damage the IC.

8) Use in strong electromagnetic field
Using the ICs in strong electromagnetic field can cause operation malfunction.

9) Radiation
This IC is not designed to be radiation-resistant.

10) IC Handling
When stress is applied to IC because of deflection or bend of board, the characteristics may fluctuate due to piezo resistance effects.

11) Inspection on set board
During testing, turn on or off the power before mounting or dismounting the board from the test Jig. Do not power up the board without waiting for the output capacitors to discharge. The capacitors in the low output impedance terminal can stress the device. Pay attention to the electro static voltages during IC handling, transportation, and storage.

12) Output capacitor
When VCC terminal is shorted to VEE (GND) potential and an electric charge has accumulated on the external capacitor, connected to output terminal, accumulated charge may be discharged VCC terminal via the parasitic element within the circuit or terminal protection element. The element in the circuit may be damaged (thermal destruction). When using this IC for an application circuit where there is oscillation, output capacitor load does not occur, as when using this IC as a voltage comparator. Set the capacitor connected to output terminal below 0.1μF in order to prevent damage to IC.

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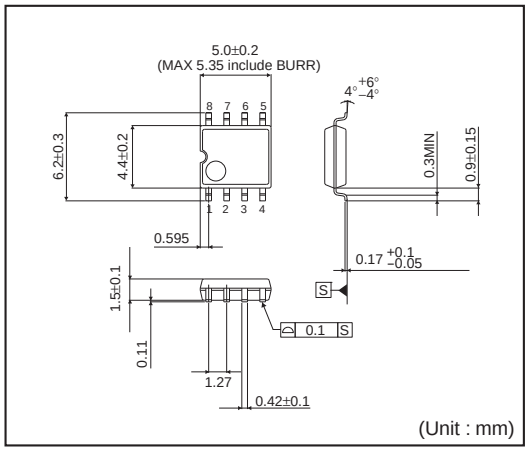
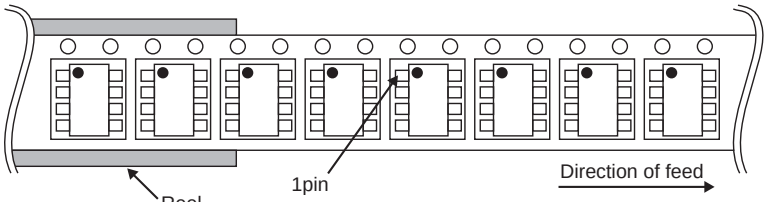
## ●Physical Dimensions Tape and Reel Information

### SOP8



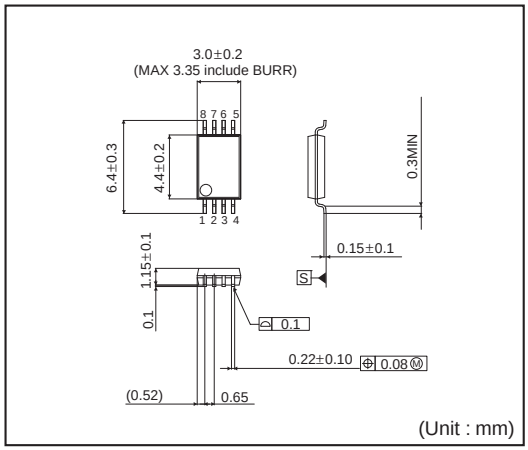

<Tape and Reel information>

| | |
|---|---|
| Tape | Embossed carrier tape |
| Quantity | 2500pcs |
| Direction of feed | E2<br>( The direction is the 1pin of product is at the upper left when you hold reel on the left hand and you pull out the tape on the right hand ) |



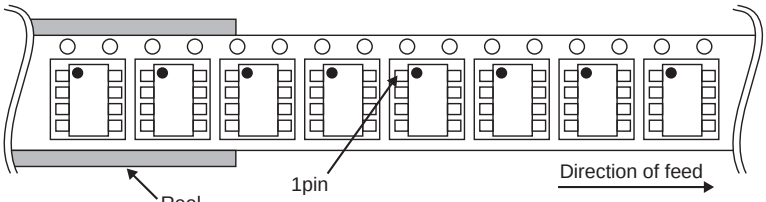

∗Order quantity needs to be multiple of the minimum quantity.

### SSOP-B8



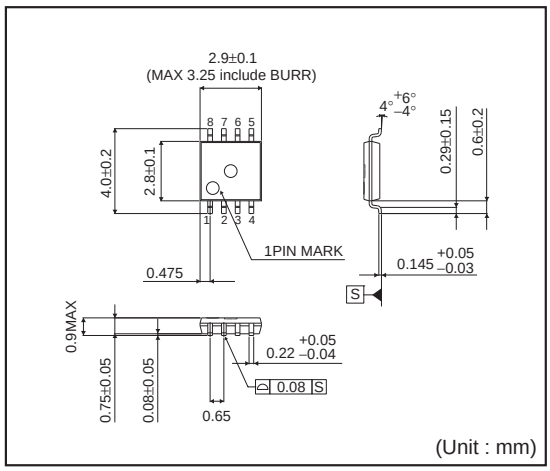

<Tape and Reel information>

| | |
|---|---|
| Tape | Embossed carrier tape |
| Quantity | 2500pcs |
| Direction of feed | E2<br>( The direction is the 1pin of product is at the upper left when you hold reel on the left hand and you pull out the tape on the right hand ) |



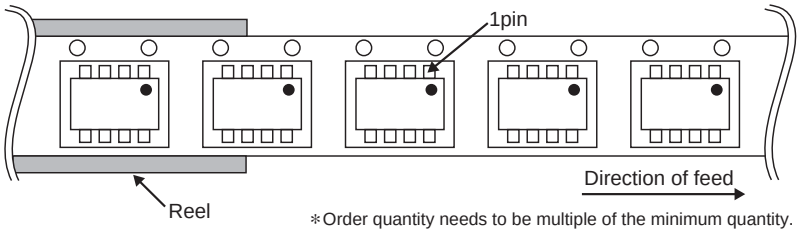

∗Order quantity needs to be multiple of the minimum quantity.

### MSOP8




<Tape and Reel information>

| | |
|---|---|
| Tape | Embossed carrier tape |
| Quantity | 3000pcs |
| Direction of feed | TR<br>( The direction is the 1pin of product is at the upper right when you hold reel on the left hand and you pull out the tape on the right hand ) |




∗Order quantity needs to be multiple of the minimum quantity.

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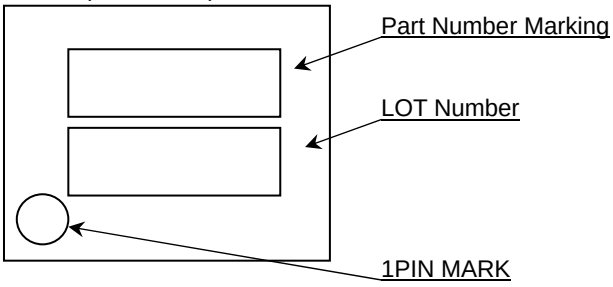
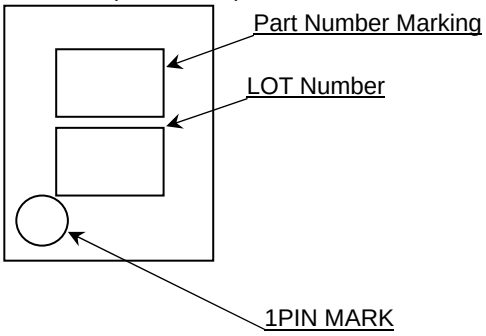
## ●Marking Diagram

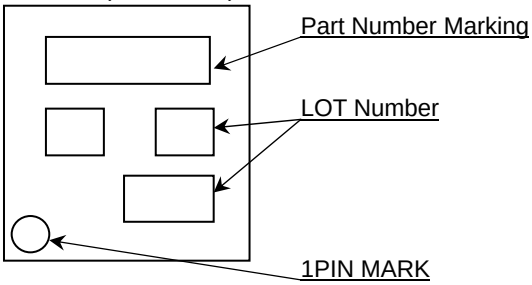
SOP8(TOP VIEW)




SSOP-B8(TOP VIEW)



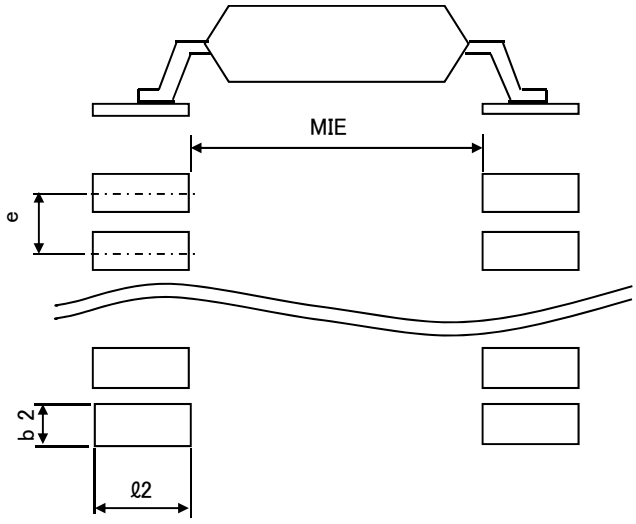

MSOP8(TOP VIEW)




| Product Name | | Package Type | Marking |
|---|---|---|---|
| BA4558Y | F-M | SOP8 | 58YM |
| | FV-M | SSOP-B8 | 58YM |
| | FVM-M | MSOP8 | 58YM |

## ●Land pattern data

SOP8, SSOP-B8, MSOP8




All dimensions in mm

| PKG | Land pitch e | Land space MIE | Land length ≧ℓ 2 | Land width b2 |
|---|---|---|---|---|
| SOP8 | 1.27 | 4.60 | 1.10 | 0.76 |
| SSOP-B8 | 0.65 | 4.60 | 1.20 | 0.35 |
| MSOP8 | 0.65 | 2.62 | 0.99 | 0.35 |

## ●Revision History

| Date | Revision | Changes |
|---|---|---|
| 20.Feb.2013 | 001 | New Release |

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| JAPAN | USA | EU | CHINA |
|---|---|---|---|
| CLASSⅢ | CLASSⅢ | CLASSⅡb | CLASSⅢ |
| CLASSⅣ | | CLASSⅢ | |

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   [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
   [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including $Cl_2$, $H_2S$, $NH_3$, $SO_2$, and $NO_2$
   [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
   [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
   [f] Sealing or coating our Products with resin or other coating materials
   [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
   [h] Use of the Products in places subject to dew condensation

4. The Products are not subject to radiation-proof design.

5. Please verify and confirm characteristics of the final or mounted products in using the Products.

6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.

7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.

8. Confirm that operation temperature is within the specified range described in the product specification.

9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

## Precaution for Mounting / Circuit board design

1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.

2. In principle, the reflow soldering method must be used; if flow soldering method is preferred, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification


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2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

## Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of Ionizer, friction prevention and temperature / humidity control).

## Precaution for Storage / Transportation

1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
   [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
   [b] the temperature or humidity exceeds those recommended by ROHM
   [c] the Products are exposed to direct sunshine or condensation
   [d] the Products are exposed to high Electrostatic

2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.

3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.

4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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# Mouser Electronics

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BA4558YFVM-MGTR BA4558YFV-MGE2 BA4558YF-MGE2

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ИНН 7805602321 КПП 780501001 Р/С 40702810122510004610 ФАКБ "АБСОЛЮТ БАНК" (ЗАО) в г.Санкт-Петербурге К/С 30101810900000000703 БИК 044030703

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- *Доставку товара в любую точку России и стран СНГ.*
- *Комплексную поставку.*
- *Работу по проектам и поставку образцов.*
- *Формирование склада под заказчика.*

- *Сертификаты соответствия на поставляемую продукцию (по желанию клиента).*
- *Тестирование поставляемой продукции.*
- *Поставку компонентов, требующих военную и космическую приемку.*
- *Входной контроль качества.*
- *Наличие сертификата ISO.*

*В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.*

*Конструкторский отдел помогает осуществить:*

- *Регистрацию проекта у производителя компонентов.*
- *Техническую поддержку проекта.*
- *Защиту от снятия компонента с производства.*
- *Оценку стоимости проекта по компонентам.*
- *Изготовление тестовой платы монтаж и пусконаладочные работы.*

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